

To our customers,

Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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Phase-out/Discontinued

GaAs MMIC DBS 4 x 2 IF SWITCH MATRIX

FEATURES

- High isolation : ISL = 40 dB TYP. @ f = 0.95 to 2.15 GHz, V_{CONT} = +5.0 V/0 V
- Control voltage : V_{CONT (H)} = +3.0 to +5.5 V (+5.0 V TYP.)
: V_{CONT (L)} = -0.5 to +0.5 V (0 V TYP.)
- Low insertion loss : L_{INS} = 6.0 dB TYP. @ f = 0.95 to 2.15 GHz, V_{CONT} = +5.0 V/0 V, Z_O = 50 Ω
- 20-pin 4 × 4 mm square micro lead package (20-pin plastic QFN (0.5 mm pitch))

APPLICATIONS

- Direct Broadcast Satellite (DBS)
- Switch Box
- 4 × 2 switch matrix to L, S band applications

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μPG2054K-E3	μPG2054K-E3-A	20-pin plastic QFN (0.5 mm pitch) (Pb-Free) ^{Note}	G2054	<ul style="list-style-type: none"> • Embossed tape 12 mm wide • Pin 1 to 5 face the perforation side of the tape • Qty 3 kpcs/reel

Note With regards to terminal solder (the solder contains lead) plated products (conventionally plated), contact your nearby sales office.

Remark To order evaluation samples, contact your nearby sales office.
Part number for sample order: μPG2054K

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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Not all devices/types available in every country. Please check with local NEC Compound Semiconductor Devices representative for availability and additional information.

ABSOLUTE MAXIMUM RATINGS (T_A = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Supply Voltage	V _{DD}	-1.0 to +6.0	V
Control Voltage	V _{CONT1 to 4}	-1.0 to +6.0	V
Total Power Dissipation	P _{tot}	2 ^{Note}	W
Input Power	P _{in}	+10	dBm
Operating Ambient Temperature	T _A	-40 to +85	°C
Storage Temperature	T _{stg}	-65 to +150	°C

Note Mounted on double-sided copper-clad 50 × 50 × 1.6 mm epoxy glass PWB, T_A = +85°C

RECOMMENDED OPERATING CONDITIONS (T_A = +25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage ^{Note}	V _{DD}	+3.0	+5.0	+5.5	V
Control Voltage (H) ^{Note}	V _{CONT (H)}	+3.0	+5.0	+5.5	V
Control Voltage (L)	V _{CONT (L)}	-0.5	0	+0.5	V

Note |V_{CONT (H)} - V_{CONT (L)}| ≥ 3.0 V, |V_{DD} - V_{CONT (H)}| ≤ 0.3 V

ELECTRICAL CHARACTERISTICS

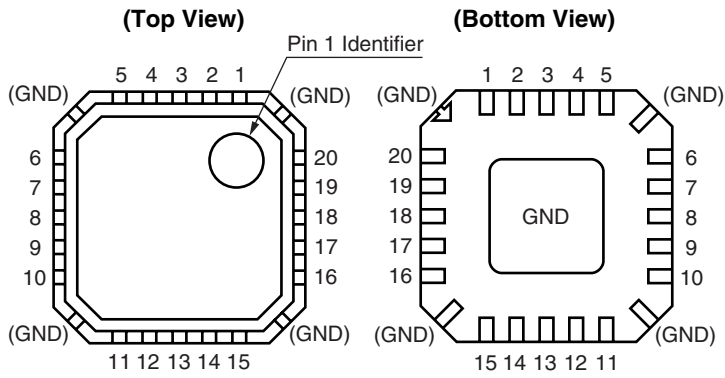
(T_A = +25°C, V_{DD} = +5.0 V, V_{CONT} = +5.0 V/0 V, P_{in} = 0 dBm, Z_o = 50 Ω, each port, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss	L _{INS}	f = 0.95 to 2.15 GHz	-	6.0	8.0	dB
Insertion Loss Flatness	ΔL _{INS}	L _{INS (0.95 GHz)} - L _{INS (2.15 GHz)}	-	0.5	1.5	dB
Isolation D/U-ratio ^{Note 1}	ISL	f = 0.95 to 2.15 GHz	35	40	-	dB
Output Return Loss	RL _{out}	f = 0.95 to 2.15 GHz	10	15	-	dB
Control Current ^{Note 2}	I _{CONT}	V _{CONT} = +5.0 V/0 V, non-RF	-	-	0.5	mA
Supply Current	I _{DD}	V _{CONT} = +5.0 V/0 V, non-RF	-	-	2.0	mA

Notes 1. Isolation D/U-ratio = |(Signal leakage (off-state)) - (Insertion loss (on-state))|

2. Per 1 control pin

PIN CONNECTIONS



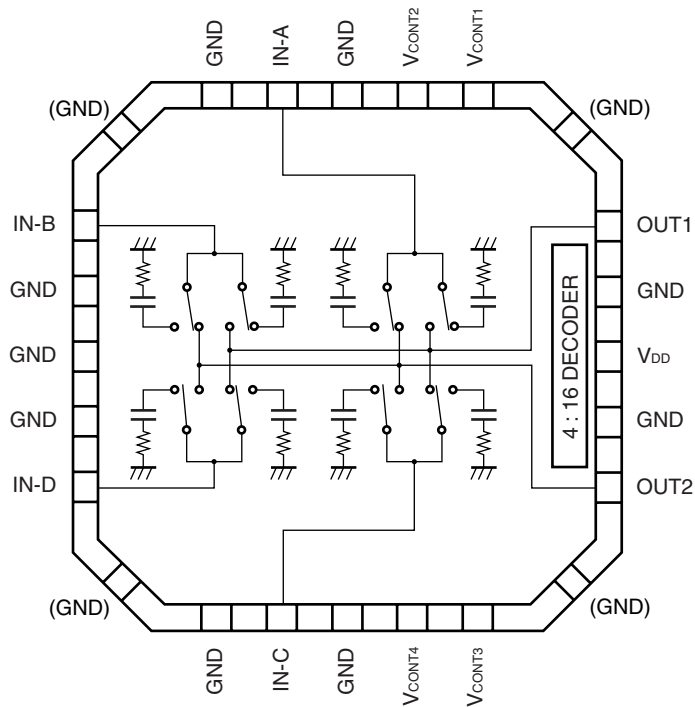
Pin No.	Pin Name	Pin No.	Pin Name
1	V _{CONT1}	11	GND
2	V _{CONT2}	12	IN-C
3	GND	13	GND
4	IN-A	14	V _{CONT4}
5	GND	15	V _{CONT3}
6	IN-B	16	OUT2
7	GND	17	GND
8	GND	18	V _{DD}
9	GND	19	GND
10	IN-D	20	OUT1

TRUTH TABLE

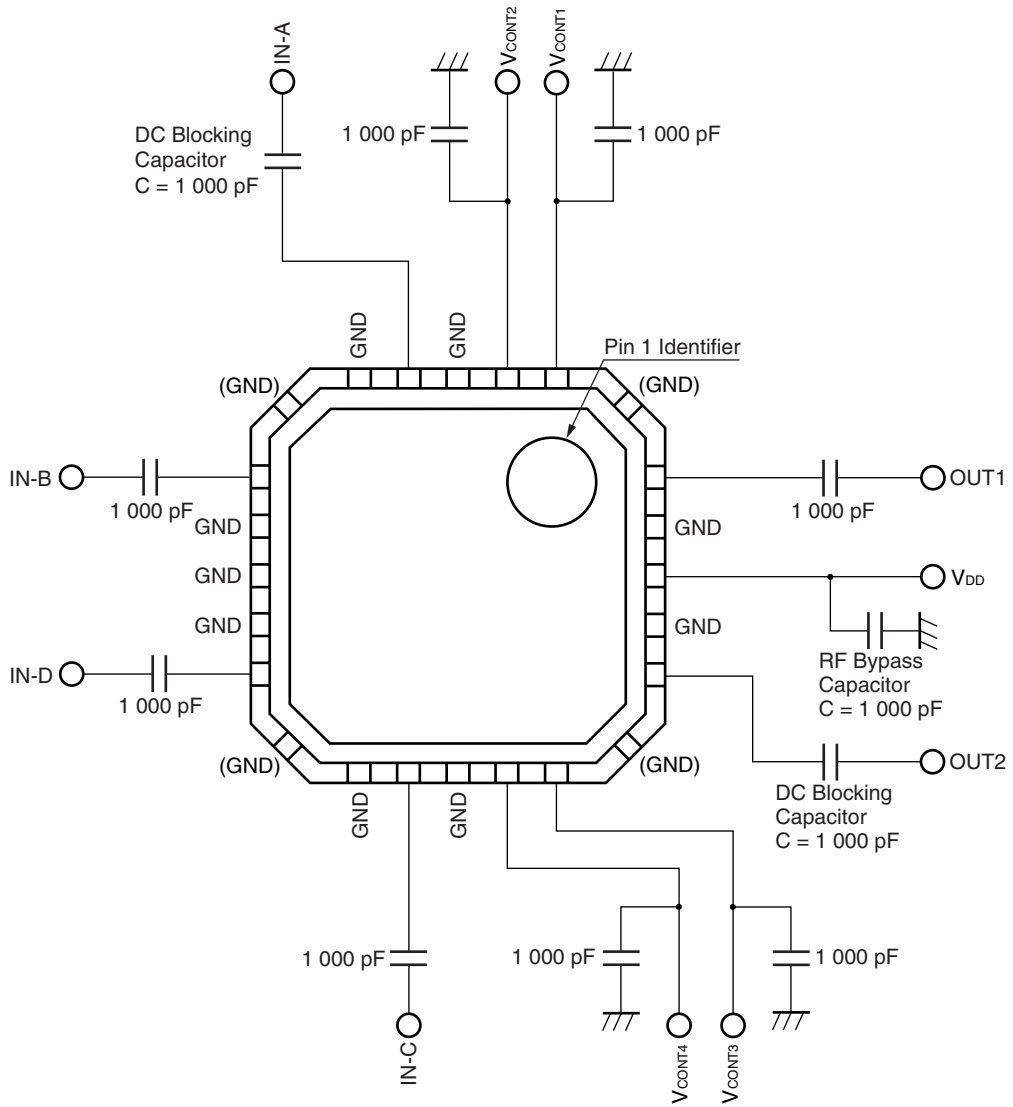
State	ON CHANNEL		CONTROL PINS			
	OUT1	OUT2	V _{CONT1}	V _{CONT2}	V _{CONT3}	V _{CONT4}
1	IN-A	IN-A	Low	Low	Low	Low
2		IN-B	Low	Low	Low	High
3		IN-C	Low	Low	High	Low
4		IN-D	Low	Low	High	High
5	IN-B	IN-A	Low	High	Low	Low
6		IN-B	Low	High	Low	High
7		IN-C	Low	High	High	Low
8		IN-D	Low	High	High	High
9	IN-C	IN-A	High	Low	Low	Low
10		IN-B	High	Low	Low	High
11		IN-C	High	Low	High	Low
12		IN-D	High	Low	High	High
13	IN-D	IN-A	High	High	Low	Low
14		IN-B	High	High	Low	High
15		IN-C	High	High	High	Low
16		IN-D	High	High	High	High

Remark High : +5 Vdc, Low : 0 Vdc.

FUNCTIONAL DIAGRAM



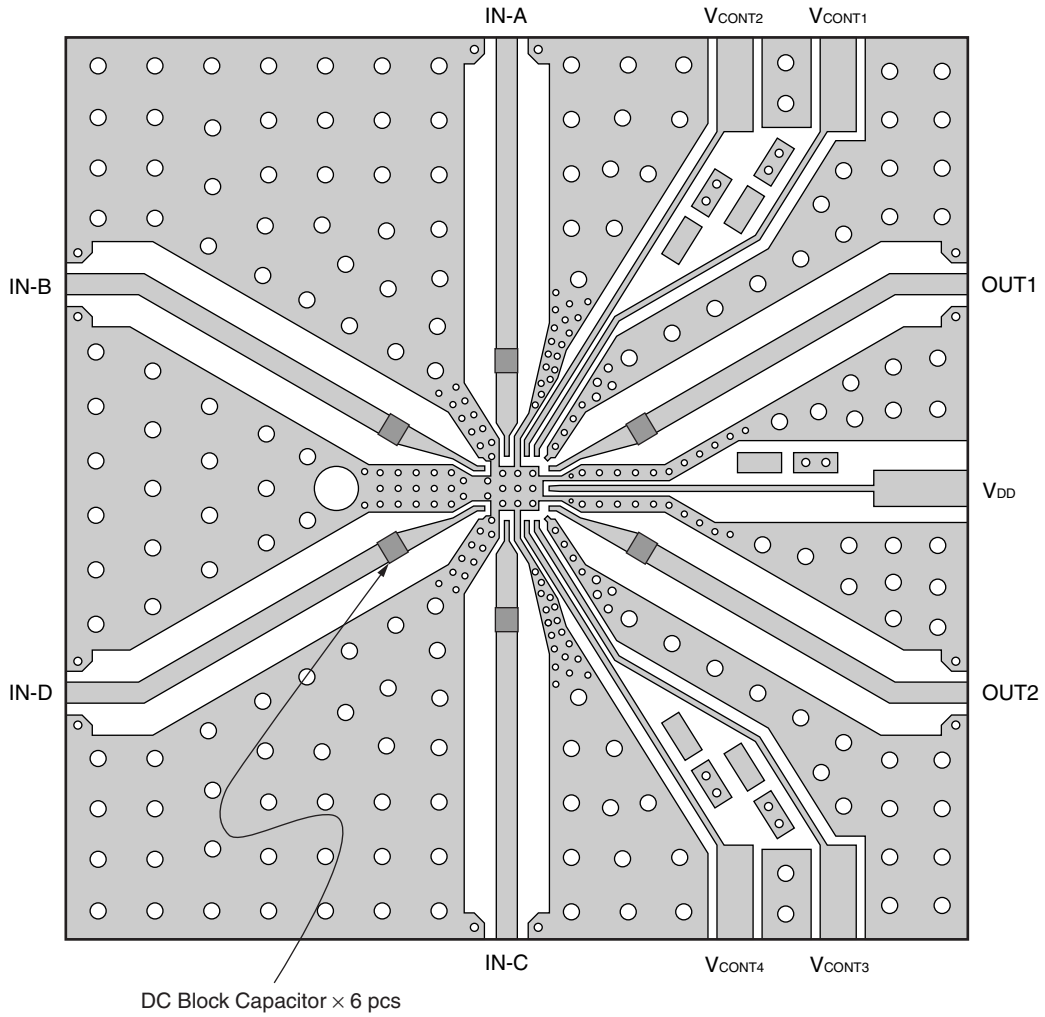
EVALUATION CIRCUIT ($V_{DD} = +5.0\text{ V}$, $V_{CONT} = +5.0\text{ V}/0\text{ V}$, $Z_o = 50\ \Omega$)



Back Side : GND

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD



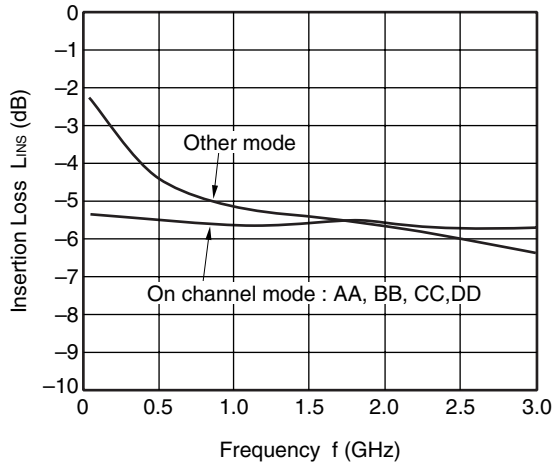
Notes

1. Size : 45 × 45 mm
2. Material : RO4003 (Rogers), t = 0.51 mm, εr = 3.38
3. ○ : Through holes

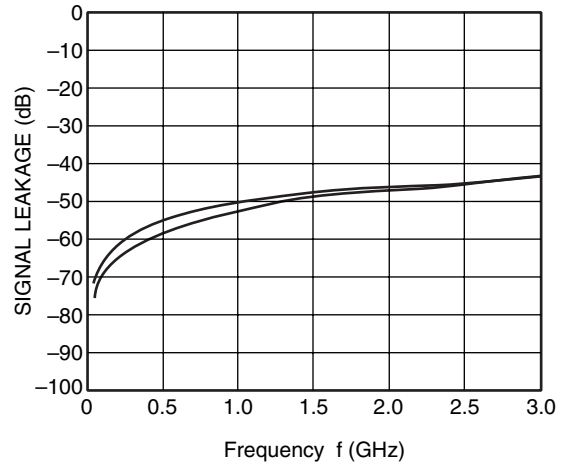
TYPICAL CHARACTERISTICS

($T_A = +25^\circ\text{C}$, $V_{DD} = +5.0\text{ V}$, $V_{CONT} = +5.0\text{ V/0 V}$, $P_{in} = 0\text{ dBm}$, $Z_o = 50\ \Omega$, unless otherwise specified)

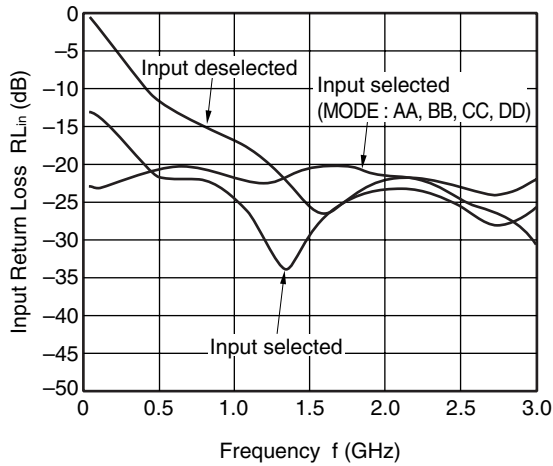
INSERTION LOSS vs. FREQUENCY



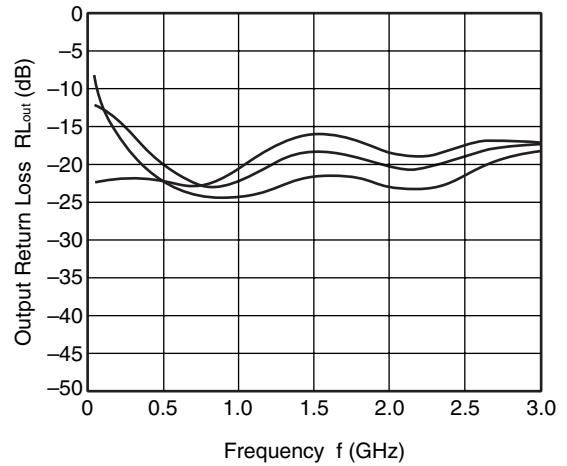
SIGNAL LEAKAGE vs. FREQUENCY



INPUT RETURN LOSS vs. FREQUENCY

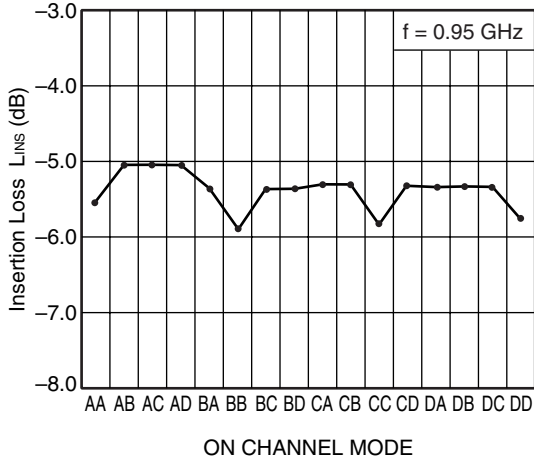


OUTPUT RETURN LOSS vs. FREQUENCY

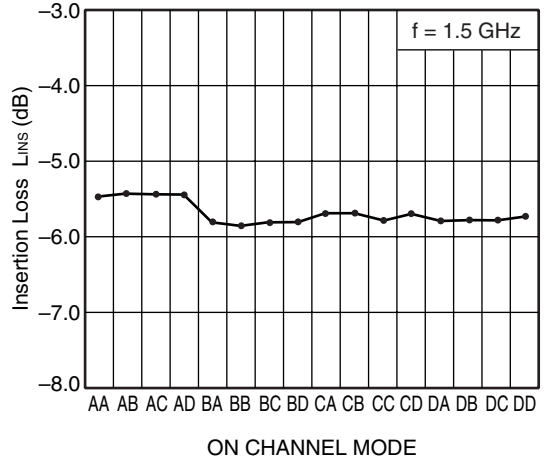


Remark The graphs indicate nominal characteristics.

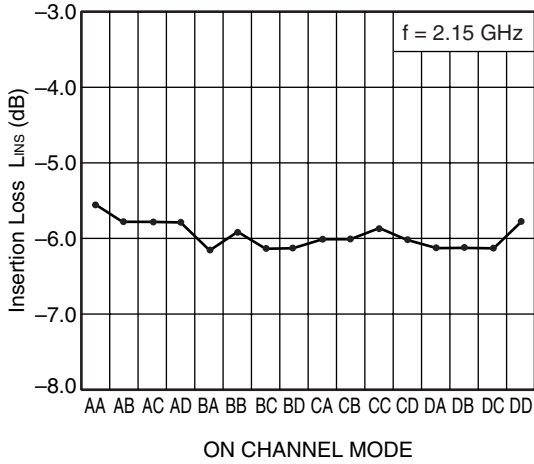
INSERTION LOSS
vs. ON CHANNEL MODE



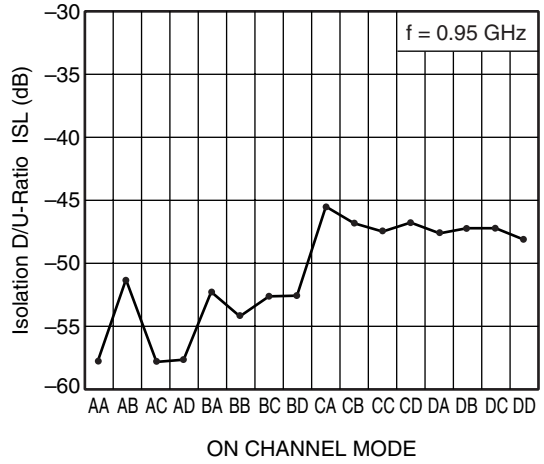
INSERTION LOSS
vs. ON CHANNEL MODE



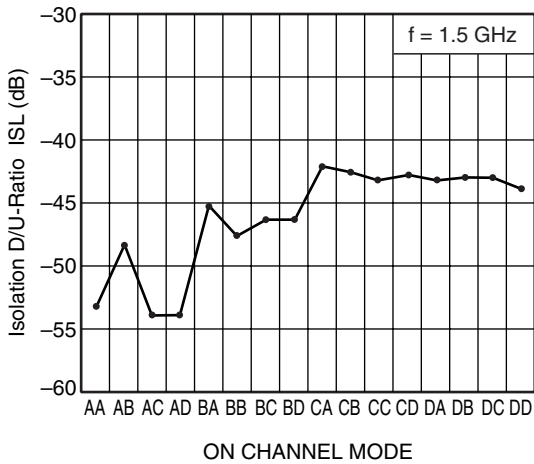
INSERTION LOSS
vs. ON CHANNEL MODE



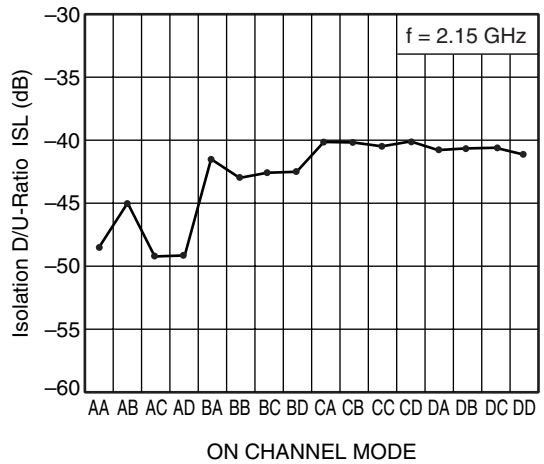
ISOLATION D/U-RATIO
vs. ON CHANNEL MODE



ISOLATION D/U-RATIO
vs. ON CHANNEL MODE

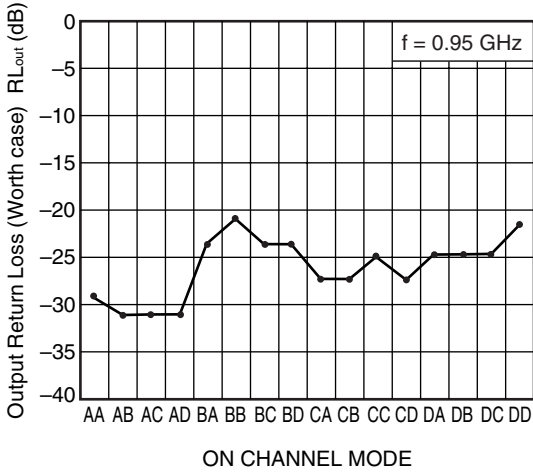


ISOLATION D/U-RATIO
vs. ON CHANNEL MODE

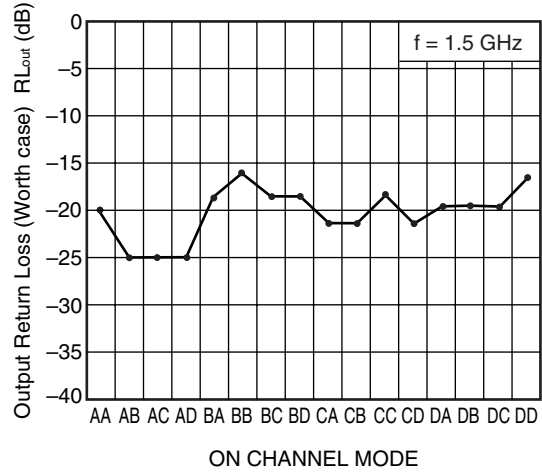


Remark The graphs indicate nominal characteristics.

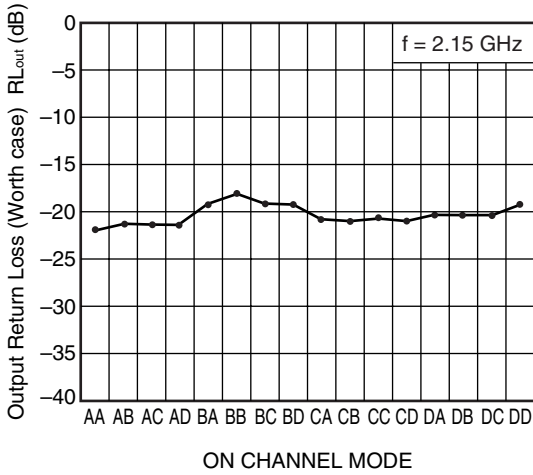
OUTPUT RETURN LOSS (WORSE CASE)
vs. ON CHANNEL MODE



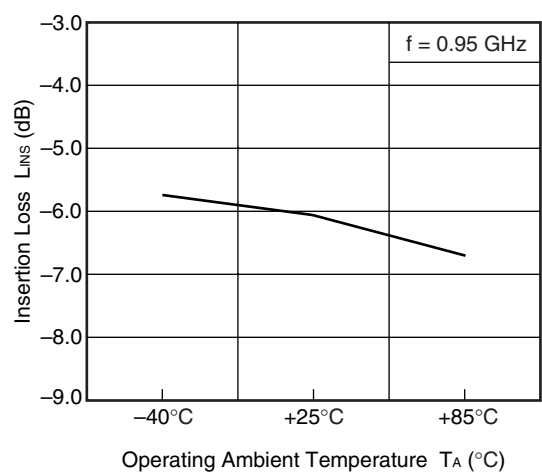
OUTPUT RETURN LOSS (WORSE CASE)
vs. ON CHANNEL MODE



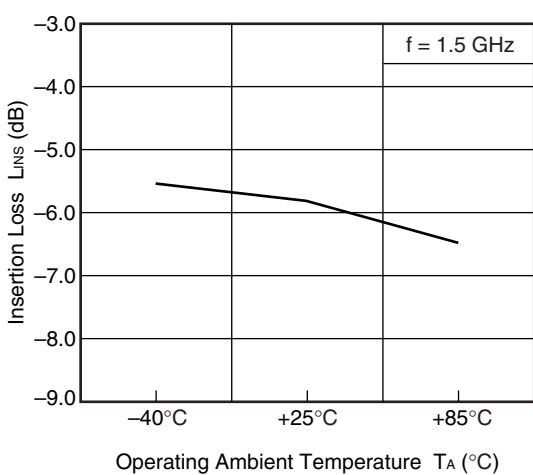
OUTPUT RETURN LOSS (WORSE CASE)
vs. ON CHANNEL MODE



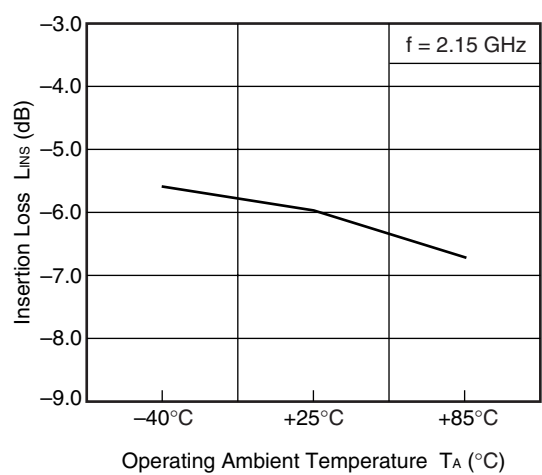
INSERTION LOSS vs.
OPERATING AMBIENT TEMPERATURE



INSERTION LOSS vs.
OPERATING AMBIENT TEMPERATURE

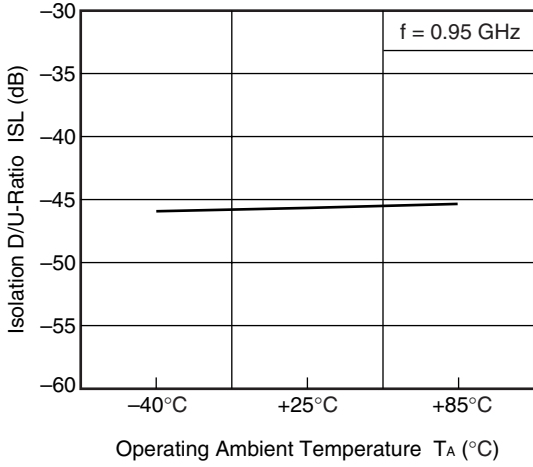


INSERTION LOSS vs.
OPERATING AMBIENT TEMPERATURE

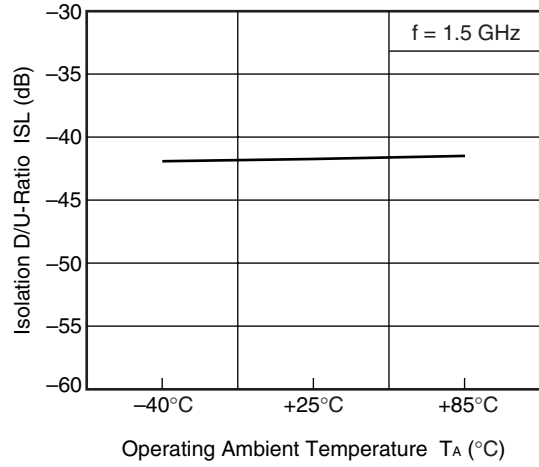


Remark The graphs indicate nominal characteristics.

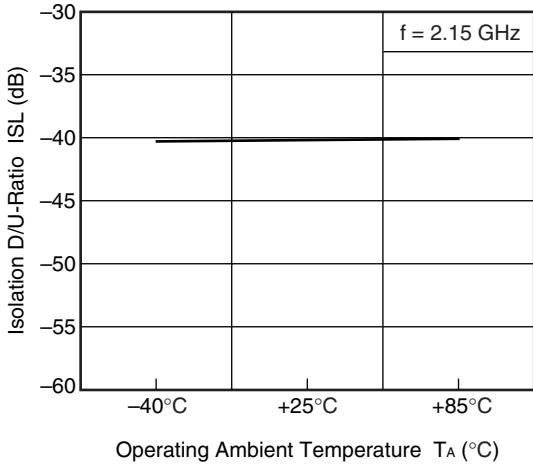
ISOLATION D/U-RATIO vs.
OPERATING AMBIENT TEMPERATURE



ISOLATION D/U-RATIO vs.
OPERATING AMBIENT TEMPERATURE



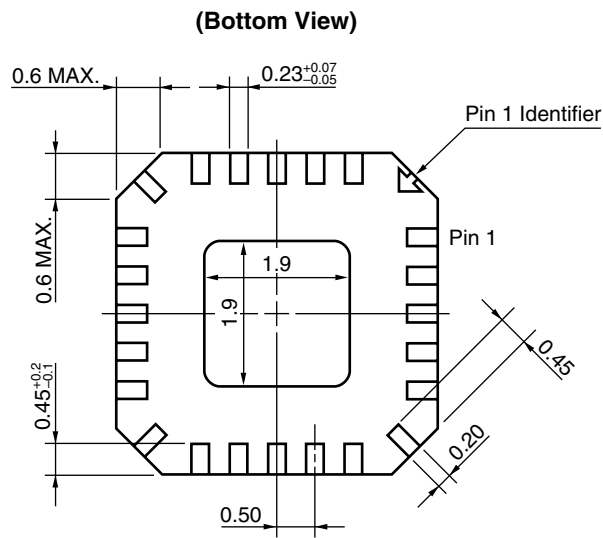
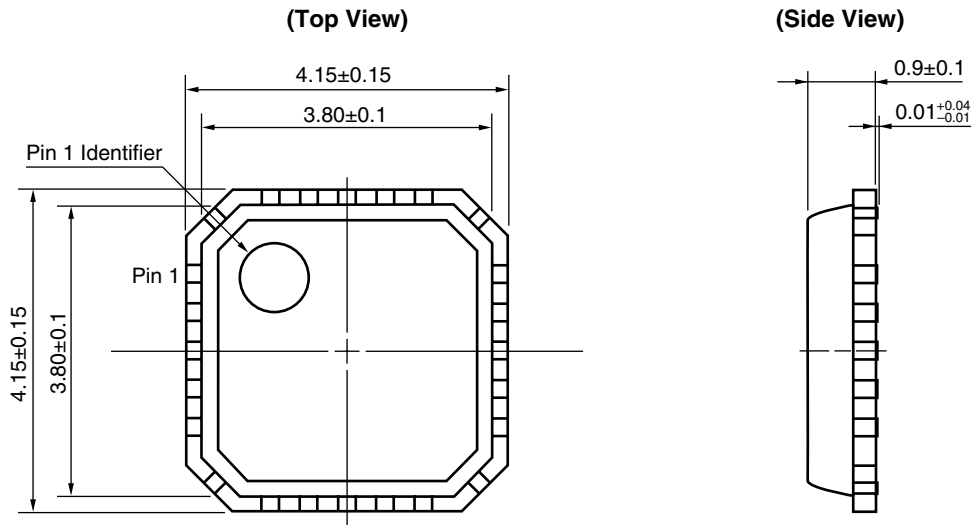
ISOLATION D/U-RATIO vs.
OPERATING AMBIENT TEMPERATURE



Remark The graphs indicate nominal characteristics.

PACKAGE DIMENSIONS

20-PIN 4 × 4 mm SQUARE MICRO LEAD PACKAGE (20-PIN QFN (0.5 mm pitch)) (UNIT: mm)



RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature)	: 260°C or below
	Time at peak temperature	: 10 seconds or less
	Time at temperature of 220°C or higher	: 60 seconds or less
	Preheating time at 120 to 180°C	: 120±30 seconds
	Maximum number of reflow processes	: 3 times
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below
Partial Heating	Peak temperature (terminal temperature)	: 350°C or below
	Soldering time (per side of device)	: 3 seconds or less
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below

Caution Do not use different soldering methods together (except for partial heating).

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 "Special": Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
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M8E 00.4-0110

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► For further information, please contact

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